

# Improved heat-spreading properties of fluorinated graphite/epoxy film

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The use of electronic devices has rapidly increased, and such devices are required to be smaller, thinner, lighter, and with higher energy densities than ever before. These requirements can result in the generation of additional heat during device operation, and this heat has detrimental effects on performance, stability, running rate, and lifespan. For instance, if the temperature of an electronic device increases by 2°C when the operating temperature is higher than the stable operating temperature, the stability of the device will be reduced by 10% [1-3]. Thus, the additional heat that such devices generate must be spread to the surrounding environment via heat sinks, coatings, or films with high thermal conductivity.

The use of coatings and films is an appropriate approach for improving the heat spread in electronic devices, particularly as these devices become lighter, smaller, and thinner. Such coatings and films are typically based on polymers such as epoxy, acryl, and polyurethane. Due to the low thermal conductivity of these polymers, it is difficult to use this approach to achieve effective heat spreading. To solve this problem, a great deal of research has addressed the addition of fillers with high thermal conductivity, such as aluminum nitride [4,5], silica (SiO<sub>2</sub>), alumina (Al<sub>2</sub>O<sub>3</sub>), boron nitride [1,6,7], graphite [8], expanded graphite (EG) [9-11], carbon nanotubes (CNTs) [11-13], graphene [9,14,15], and graphene oxide (GO) to polymer-based coatings. Recently, carbon-based materials such as graphite, EG, CNTs, graphene, and GO have been widely investigated because of their low density and high thermal conductivity. However, CNTs and graphene are not appropriate for large-scale applications due to their high production cost and complex processing. In addition, fillers with poor dispersive stability aggregate in coatings form voids, resulting in the degradation of thermal conductivity [16,17]. In this study, anionic fluorine functional groups are introduced into a graphite surface via direct fluorination to increase dispersive stability by generating electrostatic repulsion. We expect the enhanced dispersive stability of the modified graphite to lead to the formation of fewer voids, resulting in improved thermal conductivity of the prepared heat-spreading film.

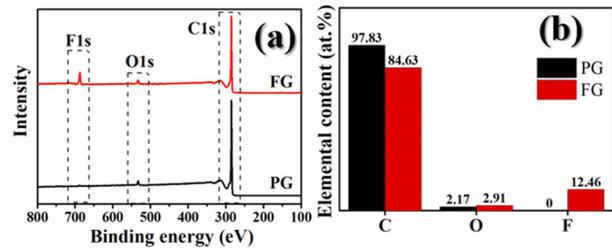
Diglycidyl ether of bisphenol A (DGEBA; YD-128, Kukdo Chemical Co., Korea) with a viscosity of 11,500 to 13,500 cP was used as the epoxy monomer, and polyamide resin (G-640, Kukdo Chemical Co.) with a viscosity of 8,000 to 12,000 cP was used as the curing agent for the epoxy resin. Acetone was used as a diluent for the epoxy resin. Fluorine gas (99.8%, Messer Griesheim GmbH, Germany) was used to introduce anionic fluorine functional groups into the graphite surface. The following fluorination method was used for this introduction. Graphite was loaded into a nickel boat and placed into a batch reactor. Degassing was performed for 1 h at room temperature using a vacuum pump. Subsequently, a mixture of fluorine gas and nitrogen gas (at a partial pressure ratio of F<sub>2</sub>:N<sub>2</sub>=1:9) at a total pressure of 1 bar was placed into the reactor, and fluorination was conducted for 10 min at room temperature. Pristine graphite and fluorinated graphite were labeled PG and FG, respectively. Filler-free coatings were prepared by mixing the epoxy resin, polyamide resin, and acetone (2:1:2 by wt%) using a planetary mixer at 2000 rpm for 1 min. Filler (PG or FG) was added (at a wt% of 10%) to the prepared coatings by continuous mixing at 2000 rpm for 5 min, and the coatings were sonicated in an ultrasonic bath for 10 min to achieve uniform dispersion. A copper plate was coated with the prepared coatings with a wet thickness of 250 μm, and then cured in an oven at 100°C for 30 min. To investigate the functional groups introduced into the surface of the PG and FG, X-ray photoelectron spectroscopy (XPS; Mul-

tiLab 2000, Thermo Electron Co., UK) analysis was performed using Al K $\alpha$  radiation (1485.6 eV), and a peak analysis program was utilized to deconvolute the C1s peaks using the pseudo-Voigt function. X-ray diffraction (XRD) and Raman spectroscopy were conducted to investigate differences in the structures of PG and FG [18]. XRD patterns generated using Cu K $\alpha$  radiation were recorded using an X'Pert PRO multipurpose X-ray diffractometer (PANalytical, the Netherlands). Raman scattering spectra were obtained using a micro-Raman spectrometer (NRS-5100, JASCO) and an excitation source with a 532 nm CW laser. UV-Vis spectrometry (Optizen 2120 UV, Mecasys, Korea) was used to investigate the dispersion of PG and FG in the tested coatings. In this analysis, the coatings were diluted to allow for detailed evaluation of the effects of the introduced fluorine functional groups on dispersion. In particular, for this assessment, the coatings were prepared using an epoxy resin:polyamide resin:acetone ratio of 2:1:7 (by wt%), and 0.1 wt% prepared graphite was then added to the diluted coatings. After samples were sonicated for 10 min, transmittance was measured at a wavelength of 700 nm for 10 h. The morphology of the prepared coatings was examined using field-emission scanning electron microscopy (FE-SEM; JSM-7500, Hitachi, Japan) to investigate the dispersion status of the graphite. The thermal conductivities of the prepared samples were measured at 50 to 250°C using laser flash method (LFA 447, NETZSCH, Germany).

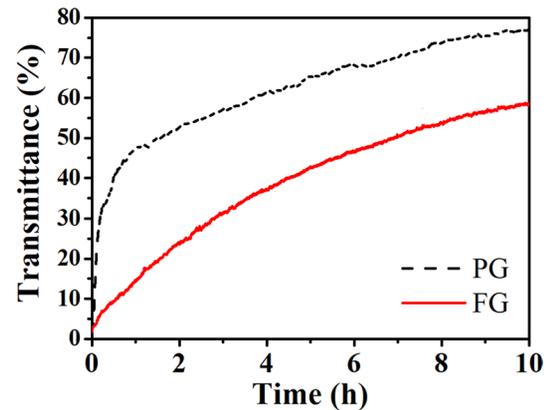
The effects of direct fluorination on the surface composition and chemical bonds of graphite were investigated using XPS. Fig. 1 shows XPS survey spectra and elemental analysis results. As shown in Fig. 1a, fluorine, oxygen, and carbon peaks were observed at binding energies of 684–694, 528–538, and 282–294 eV, respectively. Only carbon and oxygen peaks were present for PG, whereas a fluorine peak was detected on the surface of FG. In particular, in FG, fluorine was introduced at 12.46 at% after direct fluorination.

To investigate the introduced fluorine functional groups in detail, FG was analyzed via F1s deconvolution using the pseudo-Voigt function and a peak analysis program. The deconvoluted results for the F1s spectra for FG indicate that covalent and semi-covalent C–F bonds were observed at binding energies of 688.5 and 686.8 eV, respectively [19–21]. The concentrations of covalent and semi-covalent C–F bonds on the surface of FG were 9.8% and 90.2%, respectively. The FG surface has anionic properties because of the large electronegativity difference between carbon and fluorine. The fluorination-induced changes in the chemical composition on the surface of FG can generate electrostatic repulsion between each particle due to the surface negative charge of the introduced C–F bonds.

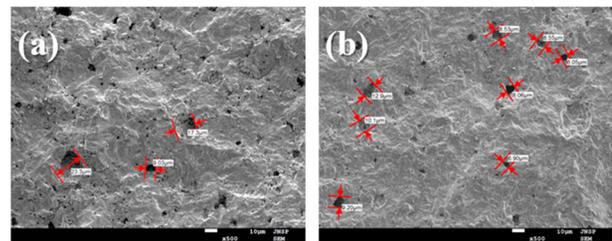
In addition, to investigate structural changes in the prepared graphite after direct fluorination, the  $D_{002}$  spacing and  $I_D/I_G$  values of the prepared graphite were evaluated using XRD and Raman spectroscopy, respectively. PG and FG had  $D_{002}$  spacing of 3.389 and 3.385, respectively, and  $I_D/I_G$  values of 2.34 and 2.27, respectively. Fluorine functional groups were introduced into the graphite surface, as described above, but no large structural changes were observed. In fact, for PG and FG,  $D_{002}$  spacing differed by less than 0.12%, and  $I_D/I_G$  differed by less than 3%. Therefore, direct fluorination can introduce anionic fluorine functional groups into the graphite surface with few structural changes.



**Fig. 1.** XPS survey spectra for PG and FG (a) and elemental content on the surface of PG and FG (b).

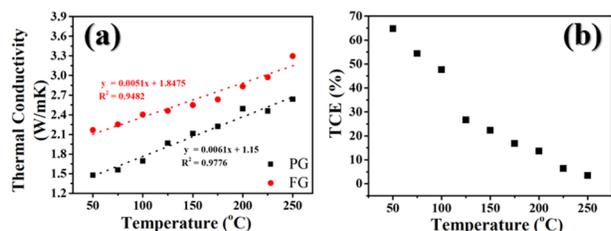


**Fig. 2.** UV-Vis transmittance spectra for PG and FG in diluted epoxy-based coatings.



**Fig. 3.** SEM images of PG-based film (a) and FG-based film (b).

The dispersive stability of the filler in coatings is an extremely important factor in the preparation of uniform coatings in which filler particles do not aggregate. To enhance the thermal conductivity of coatings via the addition of a thermally conductive filler such as graphite, which is used in this research, the aggregation of filler particles must be reduced because such aggregation results in the formation of voids in coatings after curing; the presence of such voids is known to lead to extremely low thermal conductivity. Thus, to investigate dispersive stability, the prepared graphite in coatings diluted with acetone was evaluated using UV-Vis spectrophotometry at a wavelength of 700 nm, as shown in Fig. 2 [22,23]. From the start of measurement to 10 h, the transmittances of PG and FG increased to 76.8% and 58.2%, respectively. The rate of sedimentation was higher for FG than for PG at the initial time point, as indicated by the initial slope of the graph. This phenomenon is attributable to improved dis-



**Fig. 4.** Thermal conductivities of prepared films (a) and the corresponding values for TCE (b).

persive stability of FG due to electrostatic repulsion between FG particles induced by the anionic C–F bonds introduced via direct fluorination.

Thermal conductivities of the prepared films were obtained using laser flash method at 50 to 25°C, and the experimental results are shown in Fig. 4a. These thermal conductivities increased as the measured temperature increased. Thermal conductivity was higher for the FG-based film than for the PG-based film. Thermal conductivity enhancement (TCE) for the FG-based film compared with the PG-based film was calculated by Eq 1, and the results are shown in Fig. 4b [24].

$$\text{TCE}(\%) = \frac{(TC_{FG} - TC_{PG})}{TC_{PG}} \times 100 \quad (1)$$

TCE was positive at all temperatures tested in this study but decreased as the temperature increased. In particular, at 50°C, the thermal conductivity of the FG-based film was approximately 65% greater than that of the PG-based film.

In conclusion, heat-spreading film with directly fluorinated graphite added as filler was prepared to investigate the effects of direct fluorination of the graphite surface on dispersive stability and thermal conductivity. The addition of fluorine functional groups to the graphite surface effectively enhanced dispersive stability by generating electrostatic repulsion. This alteration reduced the agglomeration of graphite particles, leading to decreases in the number of voids and void size in coatings, and thereby resulting in increased thermal conductivity. Thus, direct fluorination of graphite surfaces can improve the dispersive stability and thermal conductivity of heat-spreading film.

## Conflict of Interest

No potential conflict of interest relevant to this article was reported.

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